

EB#1 operation instruction.

- 1) Turn off the ion gauge.
- 2) Verify the circuit breaker on the high voltage power supply is off.
- 3) Press and hold the stop button for 2-3 seconds.
- 4) When the "Atmosphere" light illuminates, raise the bell jar. Do not exceed the maximum height point of the bell jar.
- 5) Verify mirror is reflective and shutter is not flaking.
- 6) Load your sample. Ensure fixture is not blocking the quartz crystal.
- 7) Open shutter by selecting "Manual" on the IC5. If it fails to open, press stop reset on the IC5.
- 8) Switch EBC mode to manual. Select pocket desired by pressing change then pocket and then enter 1 - 4 based on pocket/material assignment chart.
- 9) Load source material into the hearth pockets 1-4.
- 10) Verify crystal life by selecting "Sensors" on the IC5. Change crystal if life is >100. Press Operate to go back the main screen.
- 11) Press stop and reset to close shutter.
- 12) Lower bell jar and press Start. (The big green push button)
- 13) Turn on the circuit breaker on the high voltage power supply. Temescal CV-65LX
- 14) Switch EBC controller mode to operate. Press Manual, Mode, Operate.
- 15) From the main Operate screen on the IC5 Select "Program" then select "Process Directory". Using arrow keys, scroll to desired material and select "Process".
- 16) Enter desired rate, and final thickness. Thickness limit must match final thickness.
- 17) **IMPORTANT: Enter 1-4 for crucible. This is where you placed the source material. (Crucible on the IC5 is the same as pocket on the EBC)**
- 18) Select "Process Directory" then select "Select Active Process".
- 19) Select "Program", select "Operate".
- 20) Verify process # 1-50 is the correct process that you want to run. (Bottom left hand corner of IC5 screen)
- 21) After process pressure is reached, (<3.0X10<sup>-6</sup> torr recommended) press Stop, Reset and then Start to start the process run.
- 22) After the EBC is on the correct pocket (crucible), change the Prog # to the correct one for the material being deposited by pressing change, Prog and enter the sweep number. Touch the screen where Prog is to turn on the sweep. (White = on)
- 23) Repeat step 21 & 22 for additional layers.
- 24) When process is complete and IC5 displays "Idle" (not idle ramp) wait a minimum of 10 minutes before venting. Wait a minimum of 20 – 30 minutes for Pt, W, Ta & Mo.
- 25) Touch the screen where Prog is to turn off the sweep.
- 26) After the IC5 displays Idle (not idle ramp), turn the high voltage power supply circuit breaker to off.
- 27) Follow steps 1 – 8 to vent/remove sample and source material.

- 28) Clean up any flakes that may have occurred by using a clean room vacuum.
- 29) Lower bell jar and press Start (big green push button). Verify chamber goes into hivac before leaving the system.
- 30) Fill out the logbook.